

## 84 mΩ P-Channel MOSFET in SC-70-6

### **Features**

- · 1.8V to 5.5V input voltage range
- · Low on-resistance P-channel MOSFET
  - 70 mΩ at  $V_{GS}$  = 4.5V (typ.)
  - 2A continuous current
- VGS pull-up resistor (MIC94053)
- · SC-70-6 package
- -40°C to +150°C junction temperature range

#### **Applications**

- · Load switch in portable applications:
  - Cellular phones
  - PDAs
  - MP3 players
  - Notebook PCs
  - Barcode scanners

## **General Description**

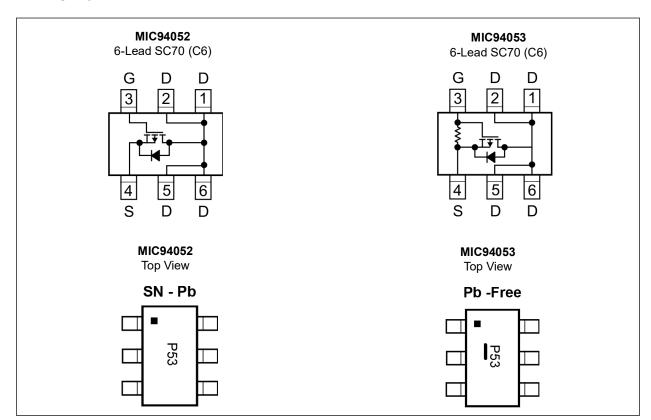
The MIC94052 and MIC94053 are low on-resistance, 84 m $\Omega_{(MAX)}$  P-channel MOSFETs. They are housed in an SC-70-6 package.

Designed for high-side switch applications where space is critical, the MIC94052/3 exhibit a typical on-resistance of 70 m $\Omega$  at 4.5V gate-to-source voltage. The devices operate down to 1.8V gate-to-source voltage. Their operating voltage range makes the MIC94052/3 ideal for lithium-ion applications as well as other sub-5V load switch applications.

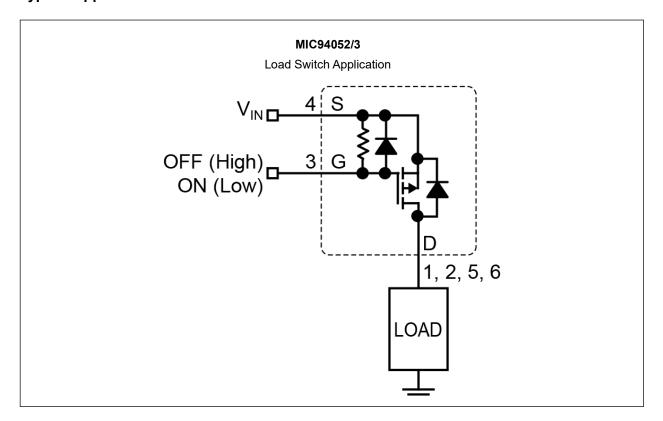
The MIC94053 is an option that includes an internal gate pull-up resistor. The pull-up resistor ensures that the P-channel MOSFET is OFF until actively pulled down. Integrating the pull-up resistor saves valuable board space and reduces component placement cost.

The MIC94052/3 have a junction temperature range of  $-40^{\circ}$ C to  $+150^{\circ}$ C.

## **Package Types**



# **Typical Application Circuits**



### 1.0 ELECTRICAL CHARACTERISTICS

## **Absolute Maximum Ratings †**

Drain-Source Voltage (V <sub>DS</sub> )	6V
Gate-Source Voltage (V <sub>GS</sub> )	
Continuous Drain Current (I <sub>D</sub> ) Note 1	
T <sub>A</sub> = 25°C	±2A
T <sub>A</sub> = 85°C	
Pulsed Drain Current (I <sub>DP</sub> ) Note 1	±6A
Continuous Diode Current (I <sub>S</sub> ) Note 2	.–50mA
Power Dissipation Note 1	
6-Lead SC-70 (T <sub>A</sub> = 85°C)	270 mW
ESD Rating Note 3	

## **Operating Ratings ‡**

Input Voltage Range (V <sub>IN</sub> )	1.8V to 5.5V
Junction Temperature Range (T <sub>J</sub> )	
Package Thermal Impedance Note 1	
θ <sub>JA</sub> SC-70-6 lead	240°C/W

- **† Notice:**  $T_A = 25^{\circ}C$  unless otherwise noted. Absolute maximum ratings indicate limits beyond which damage to the component may occur. Electrical specifications do not apply when operating the device outside of its operating ratings.
- **‡ Notice:** This device is not guaranteed to operate beyond its specified operating rating.
  - Note 1: Mounted on 1 square-inch pad of 2 oz. copper.
    - 2: Body diode current conduction is not recommended.
    - 3: IC devices are inherently ESD sensitive. Handling precautions required.

### **ELECTRICAL CHARACTERISTICS**

$T_A = 25^{\circ}C$ , unless otherwise specified. <b>Bold</b> values indicate $-40^{\circ}C \le T_J \le +150^{\circ}C$ .								
Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions		
Static								
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.5	_	-1.2	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		
Gate Body Leakage (MIC94052 only)	I <sub>GSS</sub>	_	_	100	nA	V <sub>DS</sub> = 0V, V <sub>GS</sub> = -5.5V		
Gate-Source Resistance (MIC94053 only)	R <sub>GS</sub>	250	400	550	kΩ	V <sub>DS</sub> = 0V, V <sub>GS</sub> = -5.5V		
Zero Gate Voltage Drain		_	_	-1		$V_{DS} = -5.5V, V_{GS} = 0V$		
Current	I <sub>DSS</sub>	_		-5	μA	T <sub>J</sub> = +85°C		
		_	70	84		$V_{GS} = -4.5V$ , $I_{DS} = -100$ mA		
Drain-Source On-Resistance (Note 3)	R <sub>DS(ON)</sub>	_	76	110	mΩ	$V_{GS} = -3.6V$ , $I_{DS} = -100$ mA		
		_	92	130		$V_{GS} = -2.5V$ , $I_{DS} = -100$ mA		
		_	125	180		$V_{GS} = -1.8V$ , $I_{DS} = -100 \text{ mA}$		

- **Note 1:** Pulse test; pulse width =  $300 \mu s$ , duty cycle = 2%.
  - 2: Guaranteed by design.
  - 3: Ensure that all drain pins are connected together to optimize  $R_{DS(ON)}$  performance.

# **ELECTRICAL CHARACTERISTICS (CONTINUED)**

$T_A$ = 25°C, unless otherwise specified. <b>Bold</b> values indicate $-40^{\circ}\text{C} \le T_J \le +150^{\circ}\text{C}$ .							
Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions	
Dynamic (Note 2)							
Turn-on Delay Time	t <sub>d(on)</sub>	_	15				
Turn-on Rise Time	t <sub>r</sub>		15			$V_{DD} = -5V$ , $I_D = -0.5A$ , $V_{GS} =$	
Turn-off Delay Time	t <sub>d(off)</sub>	_	60		ns	$V_{DD} = -5V$ , $I_{D} = -0.5A$ , $V_{GS} = -4.5V$ , $R_{GEN} = 50\Omega$	
Turn-off Fall Time	t <sub>f</sub>	_	20	_			

- **Note 1:** Pulse test; pulse width =  $300 \mu s$ , duty cycle = 2%.
  - 2: Guaranteed by design.
  - 3: Ensure that all drain pins are connected together to optimize R<sub>DS(ON)</sub> performance.

## **TEMPERATURE SPECIFICATIONS**

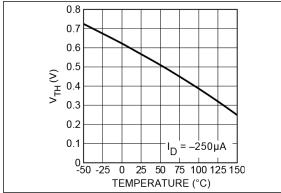
Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Operating Junction Temperature Range	TJ	<del>-4</del> 0	_	+150	°C	_
Ambient Storage Temperature Range	T <sub>S</sub>	-55	_	+150	°C	_
Thermal Resistance (6-Lead SC70)	$\theta_{JA}$	_	240		°C/W	Note 1

Note 1: Mounted on 1 square-inch pad of 2 oz. copper.

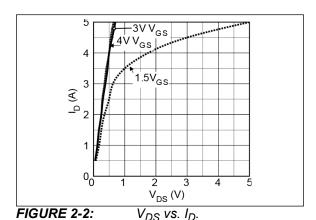
## 2.0 TYPICAL PERFORMANCE CURVES

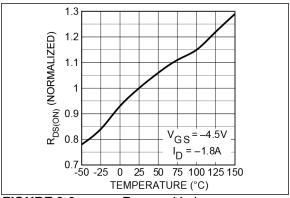
Note:

The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

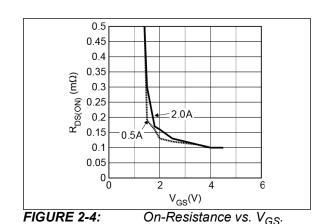


**FIGURE 2-1:** V<sub>TH</sub> Variance vs. Temperature.





**FIGURE 2-3:**  $R_{DS(ON)}$  Variance vs. Temperature.



100 1.8V V<sub>G</sub>S 200 2.5V V<sub>G</sub>S 4.5V V<sub>G</sub>S 3.3V V<sub>G</sub>S CURRENT (A)

## 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

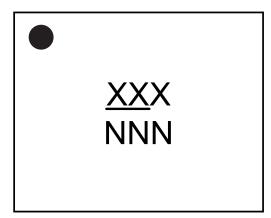
TABLE 3-1: PIN FUNCTION TABLE

Pin Number (UDFN)	Pin Name	Description
1, 2, 5, 6	D	Drain. Ensure that all drain pins are connected together to optimize RDS(ON) performance.
3	G	Gate.
4	S	Source.

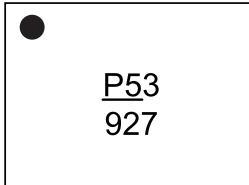
### 4.0 PACKAGING INFORMATION

# 4.1 Package Marking Information

# 6-Lead SC70



# Example



**Legend:** XX...X Product code or customer-specific information

Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

e3 Pb-free JEDEC® designator for Matte Tin (Sn)

This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.

can be found on the outer packaging for this package.

•, ▲, ▼ Pin one index is identified by a dot, delta up, or delta down (triangle mark).

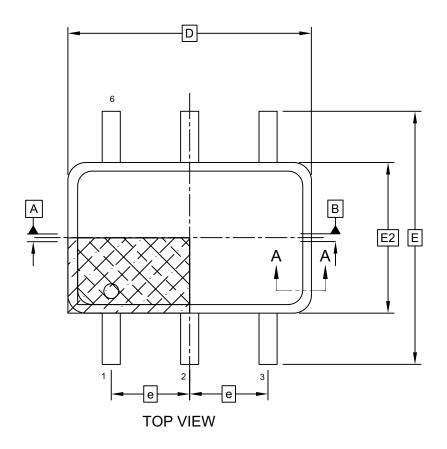
**Note**: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.

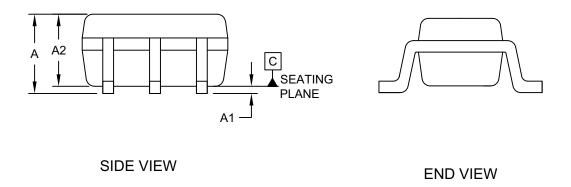
Underbar (\_) and/or Overbar (¯) symbol may not be to scale.

**Note:** If the full seven-character YYWWNNN code cannot fit on the package, the following truncated codes are used based on the available marking space: 6 Characters = YWWNNN; 5 Characters = WWNNN; 4 Characters = WNNN; 3 Characters = NNN; 2 Characters = NN; 1 Character = N.

# 6-Lead 2.0 mm × 1.25 mm SC70 [D4A] Package Outline and Recommended Land Pattern

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

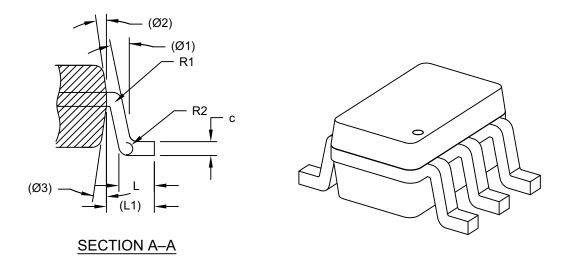




Microchip Technology Drawing C04-1133 Rev A Sheet 1 of 2

# 6-Lead 2.0 mm × 1.25 mm SC70 [D4A] Package Outline and Recommended Land Pattern

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS				
Dimer	MIN	NOM	MAX		
Number of Terminals	N		6		
Pitch	е		0.65 BSC		
Overall Height	Α	-	-	1.10	
Standoff	A1	0.00	-	0.10	
Molded Package Thickness	A2	0.80	_	1.00	
Overall Length	D	2.00 BSC			
Overall Width	E	2.10 BSC			
Molded Package Width	E2	1.25 BSC			
Terminal Width	b	0.15	_	0.30	
Terminal Thickness	С	0.08	-	0.25	
Terminal Length	L	0.21	_	0.46	
Footprint	L1		0.55 REF		
Lead Bend Radius	R1	0.02 - 0.08			
Lead Bend Radius	R2	0.08	-	0.20	
Lead Angle	θ1	12° REF			
Mold Draft Angle	θ2	8° REF			
Mold Draft Angle	θ3	8° REF			

#### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Dimensioning and tolerancing per ASME Y14.5M

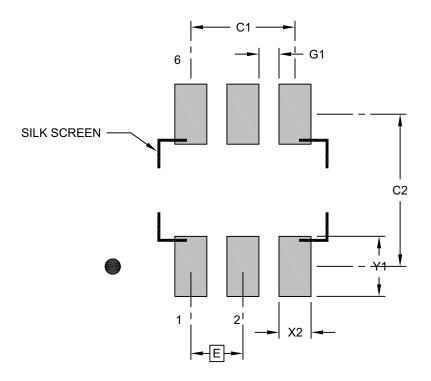
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1133 Rev A Sheet 2 of 2

# 6-Lead 2.0 mm × 1.25 mm SC70 [D4A] Package Outline and Recommended Land Pattern

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



## RECOMMENDED LAND PATTERN

	١	/ILLIMETER	S	
Dimension	MIN	NOM	MAX	
Contact Pitch	Е	0.65 BSC		
Contact Pad Spacing	C1		1.30	
Contact Pad Spacing	C2		1.90	
Contact Pad Width (X6)	X1			0.42
Contact Pad Length (X6)	Y1			0.77
Contact Pad to Contact Pad (X4)	G1	0.25		

#### Notes:

- Dimensioning and tolerancing per ASME Y14.5M
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- 2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-2133 Rev A

## **APPENDIX A: REVISION HISTORY**

# Revision A (December 2023)

- Converted Micrel document MIC94052/3 to Microchip data sheet DS20006847A.
- Minor text changes throughout.

NOTES:

# PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

Part Number	<u>x</u>	XX	- <u>XX</u>	Example	es:	
Device	Junction Temp. Range	Package	Media Type	a) MIC9	4052YC6-TR:	MIC94052, -40°C to +125°C Temperature Range, 6-Lead SC70, 3000/Reel
Device:	MIC94052/3: 84 mΩ	P-Channel MOSI	FET in SC-70-6	b) MIC9	4053YC6-TR:	MIC94053, -40°C to +125°C Temperature Range, 6-Lead SC70, 3000/Reel
Junction Temperature Range:	$Y = -40^{\circ}C \text{ to } +12$	5°C				
Package:	C6 = 6-Lead SC70					
Media Type:	TR = 3000/Reel			Note 1:	catalog part nun used for orderin the device pack	dentifier only appears in the nber description. This identifier is g purposes and is not printed on age. Check with your Microchip package availability with the option.

NOTES:

#### Note the following details of the code protection feature on Microchip products:

- Microchip products meet the specifications contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is secure when used in the intended manner, within operating specifications, and under normal conditions
- Microchip values and aggressively protects its intellectual property rights. Attempts to breach the code protection features of Microchip product is strictly prohibited and may violate the Digital Millennium Copyright Act.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of its code. Code protection does not
  mean that we are guaranteeing the product is "unbreakable" Code protection is constantly evolving. Microchip is committed to
  continuously improving the code protection features of our products.

This publication and the information herein may be used only with Microchip products, including to design, test, and integrate Microchip products with your application. Use of this information in any other manner violates these terms. Information regarding device applications is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. Contact your local Microchip sales office for additional support or, obtain additional support at <a href="https://www.microchip.com/en-us/support/design-help/client-support-services">https://www.microchip.com/en-us/support/design-help/client-support-services</a>.

THIS INFORMATION IS PROVIDED BY MICROCHIP "AS IS". MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, AND FITNESS FOR A PARTICULAR PURPOSE, OR WARRANTIES RELATED TO ITS CONDITION, QUALITY, OR PERFORMANCE.

IN NO EVENT WILL MICROCHIP BE LIABLE FOR ANY INDIRECT, SPECIAL, PUNITIVE, INCIDENTAL, OR CONSEQUENTIAL LOSS, DAMAGE, COST, OR EXPENSE OF ANY KIND WHATSOEVER RELATED TO THE INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROCHIP HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROCHIP'S TOTAL LIABILITY ON ALL CLAIMS IN ANY WAY RELATED TO THE INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, THAT YOU HAVE PAID DIRECTLY TO MICROCHIP FOR THE INFORMATION.

Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

#### **Trademarks**

The Microchip name and logo, the Microchip logo, Adaptec, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, CryptoMemory, CryptoRF, dsPlC, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Kleer, LANCheck, LinkMD, maXStylus, maXTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AgileSwitch, ClockWorks, The Embedded Control Solutions Company, EtherSynch, Flashtec, Hyper Speed Control, HyperLight Load, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, TimeCesium, TimeHub, TimePictra, TimeProvider, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, Augmented Switching, BlueSky, BodyCom, Clockstudio, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, Espresso T1S, EtherGREEN, EyeOpen, GridTime, IdealBridge, IGaT, In-Circuit Serial Programming, ICSP, INICnet, Intelligent Paralleling, IntelliMOS, Inter-Chip Connectivity, JitterBlocker, Knob-on-Display, MarginLink, maxCrypto, maxView, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, mSiC, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, Power MOS IV, Power MOS 7, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, RTAX, RTG4, SAM-ICE, Serial Quad I/O, simpleMAP, SimpliPHY, SmartBuffer, SmartHLS, SMART-I.S., storClad, SQI, SuperSwitcher, SuperSwitcher II, Switchtec, SynchroPHY, Total Endurance, Trusted Time, TSHARC, Turing, USBCheck, VariSense, VectorBlox, VeriPHY, ViewSpan, WiperLock, XpressConnect, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, and Symmcom are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2023, Microchip Technology Incorporated and its subsidiaries.

All Rights Reserved.

ISBN: 978-1-6683-3689-2

For information regarding Microchip's Quality Management Systems, please visit www.microchip.com/quality.



# Worldwide Sales and Service

#### **AMERICAS**

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199

Tel: 480-792-7200 Fax: 480-792-7277 Technical Support:

http://www.microchip.com/

support Web Address:

www.microchip.com

**Atlanta** Duluth, GA

Tel: 678-957-9614 Fax: 678-957-1455

**Austin, TX** Tel: 512-257-3370

Boston

Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL

Tel: 630-285-0071 Fax: 630-285-0075

Dallas

Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

**Detroit** Novi. MI

Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Tel: 281-894-598 Indianapolis

Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453 Tel: 317-536-2380

Los Angeles

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

**Raleigh, NC** Tel: 919-844-7510

New York, NY Tel: 631-435-6000

**San Jose, CA** Tel: 408-735-9110 Tel: 408-436-4270

**Canada - Toronto** Tel: 905-695-1980 Fax: 905-695-2078

#### ASIA/PACIFIC

Australia - Sydney Tel: 61-2-9868-6733

**China - Beijing** Tel: 86-10-8569-7000

China - Chengdu Tel: 86-28-8665-5511

**China - Chongqing** Tel: 86-23-8980-9588

**China - Dongguan** Tel: 86-769-8702-9880

**China - Guangzhou** Tel: 86-20-8755-8029

**China - Hangzhou** Tel: 86-571-8792-8115

China - Hong Kong SAR Tel: 852-2943-5100

China - Nanjing Tel: 86-25-8473-2460

China - Qingdao Tel: 86-532-8502-7355

**China - Shanghai** Tel: 86-21-3326-8000

**China - Shenyang** Tel: 86-24-2334-2829

China - Shenzhen

Tel: 86-755-8864-2200

**China - Suzhou** Tel: 86-186-6233-1526

**China - Wuhan** Tel: 86-27-5980-5300

China - Xian

Tel: 86-29-8833-7252 China - Xiamen

Tel: 86-592-2388138 **China - Zhuhai** Tel: 86-756-3210040

#### ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444

India - New Delhi Tel: 91-11-4160-8631

India - Pune Tel: 91-20-4121-0141

**Japan - Osaka** Tel: 81-6-6152-7160

**Japan - Tokyo** Tel: 81-3-6880- 3770

Korea - Daegu

Tel: 82-53-744-4301

**Korea - Seoul** Tel: 82-2-554-7200

Malaysia - Kuala Lumpur Tel: 60-3-7651-7906

Malaysia - Penang Tel: 60-4-227-8870

Philippines - Manila Tel: 63-2-634-9065

**Singapore** Tel: 65-6334-8870

**Taiwan - Hsin Chu** Tel: 886-3-577-8366

Taiwan - Kaohsiung Tel: 886-7-213-7830

**Taiwan - Taipei** Tel: 886-2-2508-8600

Thailand - Bangkok Tel: 66-2-694-1351

Vietnam - Ho Chi Minh Tel: 84-28-5448-2100

#### **EUROPE**

**Austria - Wels** Tel: 43-7242-2244-39

Fax: 43-7242-2244-393

Denmark - Copenhagen Tel: 45-4485-5910

Fax: 45-4485-2829 Finland - Espoo Tel: 358-9-4520-820

France - Paris

Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Garching Tel: 49-8931-9700

**Germany - Haan** Tel: 49-2129-3766400

Germany - Heilbronn Tel: 49-7131-72400

Germany - Karlsruhe Tel: 49-721-625370

**Germany - Munich** Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Germany - Rosenheim Tel: 49-8031-354-560

**Israel - Ra'anana** Tel: 972-9-744-7705

Italy - Milan

Tel: 39-0331-742611 Fax: 39-0331-466781

**Italy - Padova** Tel: 39-049-7625286

**Netherlands - Drunen** Tel: 31-416-690399 Fax: 31-416-690340

Norway - Trondheim Tel: 47-7288-4388

**Poland - Warsaw** Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

**Spain - Madrid** Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Gothenberg Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

**UK - Wokingham** Tel: 44-118-921-5800 Fax: 44-118-921-5820